

Excellent Integrated System Limited

Stocking Distributor

Click to view price, real time Inventory, Delivery & Lifecycle Information:

[FCI](#)
[71257-0000LF](#)

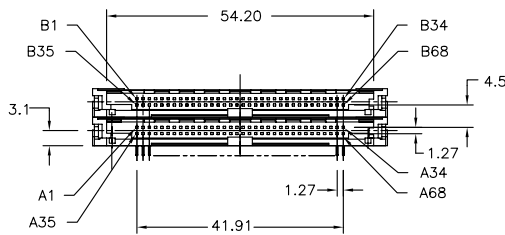
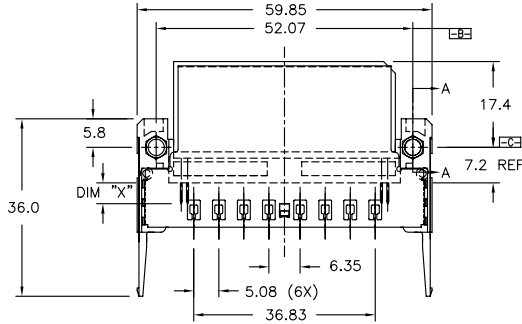
For any questions, you can email us directly:
sales@integrated-circuit.com

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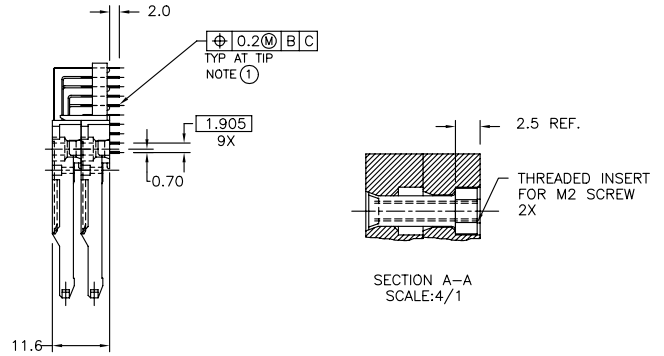
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PRODUCT NO.	DIM "X"		
71257-0000	4.25±0.1	3.5±0.1	5±0.1
71257-0000LF	OTHERS	36,67	1,17,34 35,51,68



NOTES:

- TRUE POSITION IS A FREE GRID TO THE PIN PATTERN ITSELF.
- MATERIAL:
 PLASTIC: HIGH TEMPERATURE THERMOPLASTIC UL94V-0 BLACK
 PIN: COPPER ALLOY
- FINISH (PIN):
 UNDER PLATING: 0.5 µM MIN. Ni
 CONTACT AREA: 0.076 µM MIN. GOLD
 SOLDER AREA: 2.5 µM MIN. Sn-Pb
 LEAD FREE SOLDER TAIL PLATING 2µm (80u") MIN. MATTE TIN
 OVER 1.27µm (50u") MIN. NICKEL UNDERPLATE.
- RECOMMENDED SCREW TORQUE: 1.0 TO 1.5 MAX in-lbs.
 (1.2-1.7 cm-kgs). RECOMMENDED HOLD DOWN: 2mm
 SCREWS (95121-002) AND HEX NUTS (92869-001).
- IF LEAD FREE PART NUMBER, THE HOUSING WILL WITHSTAND EXPOSURE TO 260° C
 PEAK TEMPERATURE FOR 10 SECONDS IN A WAVE SOLDER APPLICATION WITH A
 1.60mm MIN. THICK CIRCUIT BOARD.
- PACKAGING SPECIFICATION: GS-14-415.
 PACKAGING OF LEAD FREE PRODUCTS MEETS LABELING AND PACKAGING
 SPECIFICATION GS-14-920.
- LEAD FREE PRODUCTS MEET EUROPEAN UNION DIRECTIVES AND OTHER COUNTRY
 REGULATIONS AS DESCRIBED IN GS-22-008.
- PRODUCT SPEC: 110-263



mat'l. code	surface	tolerance	projection	product family
	ISD1302 ✓	ISD406 ISD1101	MM	PCMCIA
tr ecn no dr date	tolerances unless otherwise specified	angle	title	
A V60110 RHG 01/04/96	0.XX±0.3	MM	RIGHT ANGLE DOUBLE DECK	
B V70388 RHG 05/22/97	0.XX±0.13	MM	CARDBUS HEADER ASSEMBLY	
C V12254 TFG 09/24/01	0.XXX±0.05	scale 1:1		
D V12254 HTB 10/08/03	dir	D.SHEAFFER 08/11/95	FCI	dwg no sheet 1 of 2 size
E N05-0057 DAI 03/30/05	engr	D.BRANN 08/11/95		71257 A4
F BX-9-0794 ZK 11/01/11	chr	D.BRANN 08/11/95		type Product Customer Drawing
G BX-9-01402 ZK 04/23/12	appd	D.BRANN 08/11/95		
sheet revision 6				
index sheet 1 2				

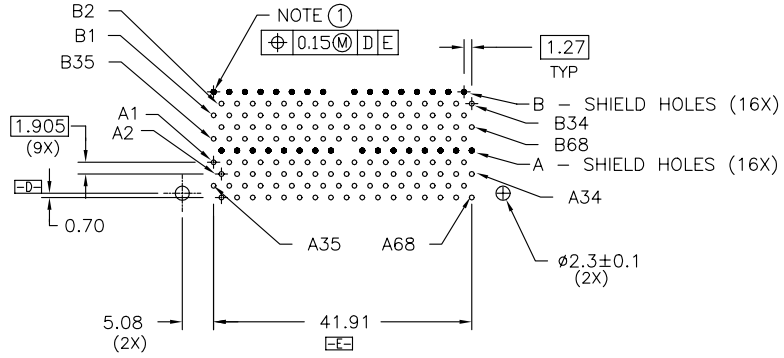


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NOTES:

- ① RECOMMENDED DIAMETER IS $\phi 1.0$. FOR PROCESSES USING PASTE REFLOW, HOLE MAY BE AS SMALL AS $\phi 0.79$.
- 2 ALL TOLERANCES ± 0.15 UNLESS NOTED.

mat'l. code	surface	tolerance	projection	product family
	ISD1302	ISD406 ISD1101	$\phi 1$	PCMCIA
tr	ec	nd	dr	date
tolerances unless otherwise specified				title
g	angles	$0.X \pm 0.3$	MM	RIGHT ANGLE DOUBLE DECK
	radius	$0.XX \pm 0.13$	scale 1:1	CARDBUS HEADER ASSEMBLY
	$0 \pm x$	$0.XXX \pm 0.05$		dwg no
	dr	D.SHEAFFER 08/11/95		71257
	enr	D.BRANN 08/11/95		sheet 2 of 2
	chr	D.BRANN 08/11/95		size
	appd	D.BRANN 08/11/95		A4
sheet	revision			type
index	sheet			Product Customer Drawing